10/533238

Page 1 of 5

Docket	No.	

Declaration and Power of Attorney For Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for

which a patent is sought	on the invention enti-	uea.	
METHOD OF FORMING A		A-BASED COATING FILM WI ASED COATING FILM	TH LOW DIELECTRIC
the specification of which (check one) ☐is attached here ☑ was filed on _C Application Nur and was amend	eto. October 27, 2003_ as nber <u>PCT/JP0</u> ded on	United States Application No 03/ 13691 licable)	o. or PCT International
		stand the contents of the abound in the contents of the abound in the contents of the contents	ve identified specification,
I acknowledge the duty to known to me to be mate Section 1.56.	o disclose to the Unit erial to patentability	ted States Patent and Trader as defined in Title 37, Code	mark Office all information e of Federal Regulations,
Section 365(b) of any fo any PCT International ap listed below and have als	reign application(s) f plication which desig to identified below, by CT International appl	r Title 35, United States Co for patent or inventor's certifinated at least one country othy checking the box, any foreig ication having a filing date be	cate, or Section 365(a) of ner than the United States, on application for patent or
Prior Foreign Application	(s)		Priority Not Claimed
2002-318418 (Number)	Japan (Country)	31/10/2002 (Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	-

I hereby claim the benefit und application(s) listed below:	der 35 U.S.C. Section 1	19(e) of any United States provisional
(Application Serial No.)	(Filing Date)	<u>-</u>
	• ,	<u>_</u>
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	_ · · · · · · · · · · · · · · · · · · ·
States or PCT International appl Section 112. Lacknowledge the all information known to me to be	lication in the manner prov duty to disclose to the Uni e material to patentability as en the filing date of the pr	ation is not disclosed in the prior United vided by the first paragraph of 35 U.S.C. ited States Patent and Trademark Offices defined in Title 37, C.F.R., Section 1.56 ior application and the national or PCT
	·	· · · · · · · · · · · · · · · · · · ·
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.



Benjamin J. Hauptman Reg. No. 29,310 Manabu Kanesaka Reg. No. 31,467 Kenneth M. Berner Reg. No. 37,093

Send Correspondence to:

HAUPTMAN KANESAKA & BERNER 1700 Diagonal Road, Suite 310, Alexandria, VA 22314

Direct Telephone Calls to:

Manabu Kanesaka at telephone number (703) 519-9785

	Full name of sole or first inventor					
	Akira Nakashima					
	Sole or first inventor's signature Date					
	akiri hakashmi 28/3/2005					
	Residence					
	Fukuoka, Japan JPX					
•	Citizenship					
ı	Japanese					
	Post Office Address					
	c/o Wakamatsu Factory, Catalysts & Chemicals Industries Co., Ltd.,					
	13-2, Kitaminatomachi, Wakamatsu-ku, Kitakyushu-shi, Fukuoka, Japan					
	Full name of second inventor					
	Miki Egami					
,	Second inventor's signature Date					
	Miki Egami 28/3/2005					
	Residence					
ے	Fukuoka, Japan USX					
	Citizenship					
	Japanese					
	Post Office Address					
	c/o Wakamatsu Factory, Catalysts & Chemicals Industries Co., Ltd.,					
	13-2, Kitaminatomachi, Wakamatsu-ku, Kitakyushu-shi, Fukuoka, Japan					

2-20

00-8

Full name of third inventor				
Michio Komatsu				
Third inventor's signature Date				
michie gromatin 28/0/2005				
Residence				
Fukuoka Japan J X				
Citizenship				
Japanese				
Post Office Address				
c/o Wakamatsu Factory, Catalysts & Chemicals Industries Co., Ltd., 13-2, Kitaminatomachi, Wakamatsu-ku, Kitakyushu-shi, Fukuoka, Japan				
Full name of fourth inventor				
Yoshihiro Nakata				
Fourth inventor's signature Date				
Residence				
Kanagawa, Japan				
Citizenship				
Japanese				
Post Office Address				
c/o Fujitsu Limited, 1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan				
Full name of fifth inventor				
Ei Yano				
Fifth inventor's signature Date				
Residence				
Kanagawa, Japan				
Citizenship				
Japanese				
Post Office Address				
c/o Fujitsu Limited, 1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan				
·				

Full name of sixth inventor	
Katsumi Suzuki	
Sixth inventor's signature	Date
Residence	
4-138-102, Inoue-cho, Toyota-shi, Aichi, Japan	
Citizenship	
Japanese	
Post Office Address	